

LNPT[™] THERMOTUF[™] COMPOUND IX02582

PDX-I-02582
REGION ASIA

DESCRIPTION

LNP THERMOTUF IX02582 compound is based on Nylon 6/12 resin containing 40% glass fiber. Added features of this grade include: Impact Modified.

GENERAL INFORMATION	
Features	High stiffness/Strength, Impact resistant, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyamide 612 (Nylon 612)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Building Component
Consumer	Sport/Leisure, Home Appliances, Commercial Appliance
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical, Defense

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, break	174	MPa	ASTM D638
Flexural Modulus	10340	MPa	ASTM D790
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	208	J/m	ASTM D256
PHYSICAL ⁽¹⁾			
Density	1.41	g/cm ³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.25	%	ASTM D570

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

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